

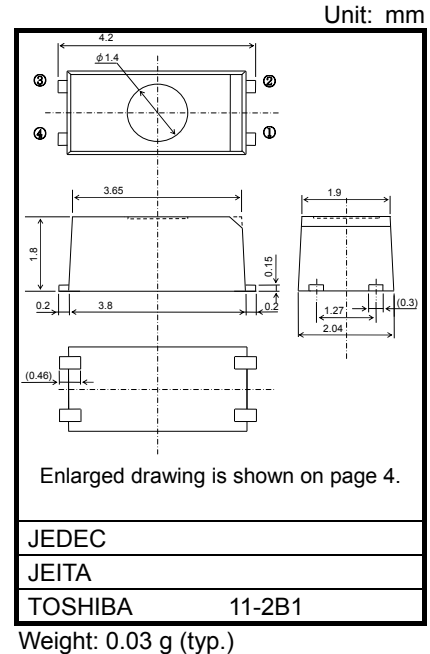
TLP3220

Memory Tester
 Logic Tester
 Measurement Instrument

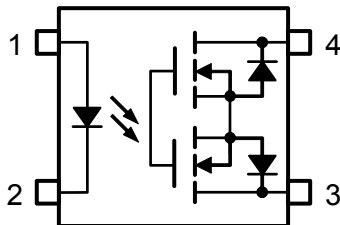
The TOSHIBA TLP3220 is a super small-outline photorelay, suitable for surface-mount assembly. The TLP3220 consists of a GaAs infrared-emitting diode optically coupled to a photo-MOS FET and housed in a 4-pin package.

Features

- 4 pin SSOP (SSOP4) : 1.8 mm high, 1.27 mm pitch
- 1-Form-A
- Peak off-state voltage : 100 V (Min.)
- Trigger LED current : 5 mA (Max.)
- On-state current : 80 mA (Max.)
- On-state resistance : 14 Ω (Max.), 8 Ω (Typ.)
- Output capacitance : 8 pF (Max.), 6 pF (Typ.)
- Isolation voltage : 1500 V_{rms} (Min.)

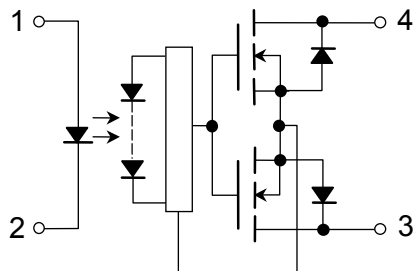


Pin configuration (top view)



- 1 : Anode
- 2 : Cathode
- 3 : Drain
- 4 : Drain

Schematic



Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit
LED	Forward current	I _F	50	mA
	Forward current derating (Ta ≥ 25°C)	ΔI _F /°C	-0.5	mA/°C
	Reverse voltage	V _R	5	V
	Junction temperature	T _j	125	°C
Detector	Off-State output terminal voltage	V _{OFF}	100	V
	On-State current	I _{ON}	80	mA
	On-State current derating (Ta ≥ 25°C)	ΔI _{ON} /°C	-0.8	mA/°C
	Junction temperature	T _j	125	°C
Storage temperature range		T _{stg}	-40~125	°C
Operating temperature range		T _{opr}	-20~85	°C
Lead soldering temperature (10 s)		T _{sol}	260	°C
Isolation voltage (AC, 1 min., R.H. ≤ 60%) (Note 1)		BV _S	1500	V _{rms}

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1): Device considered a two-terminal device: Pins 1 and 2 shorted together, and pins 3 and 4 shorted together.

Precautions

This device is sensitive to electrostatic discharge. When using this device, please ensure that all tools and equipment are earthed.

Recommended Operating Conditions

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Supply voltage	V _{DD}	—	—	80	V
Forward current	I _F	10	—	30	mA
Operating temperature	T _{opr}	25	—	60	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Individual Electrical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min.	Typ.	Max.	Unit
LED	Forward voltage	V _F	I _F = 10 mA	1.0	1.15	1.3	V
	Reverse current	I _R	V _R = 5 V	—	—	10	μA
	Capacitance	C _T	V = 0, f = 1 MHz	—	15	—	pF
Detector	Off-state current	I _{OFF}	V _{OFF} = 80 V	—	—	200	pA
			V _{OFF} = 100 V	—	—	1	μA
	Capacitance	C _{OFF}	V = 0, f = 100 MHz, t < 1 s	—	6	8	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Trigger LED current	I_{FT}	$I_{ON} = 80 \text{ mA}$	—	1	5	mA
Return LED current	I_{FC}	$I_{OFF} = 1 \text{ } \mu\text{A}$	0.2	—	—	mA
On-state resistance	R_{ON}	$I_{ON} = 80 \text{ mA}, I_F = 10 \text{ mA}, t = 10 \text{ ms}$	—	8	14	Ω

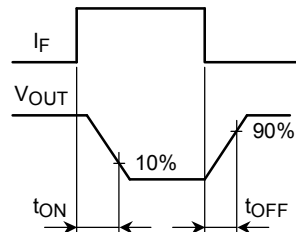
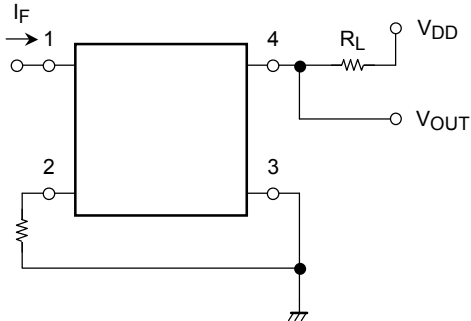
Isolation Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Capacitance input to output	C_S	$V_S = 0 \text{ V}, f = 1 \text{ MHz}$	—	0.6	—	pF
Isolation resistance	R_S	$V_S = 500 \text{ V}, \text{R.H.} \leq 60\%$	5×10^{10}	10^{14}	—	Ω
Isolation voltage	BV_S	AC, 1 minute	1500	—	—	Vrms
		AC, 1 second (in oil)	—	3000	—	—
		DC, 1 minute (in oil)	—	3000	—	Vdc

Switching Characteristics (Ta = 25°C)

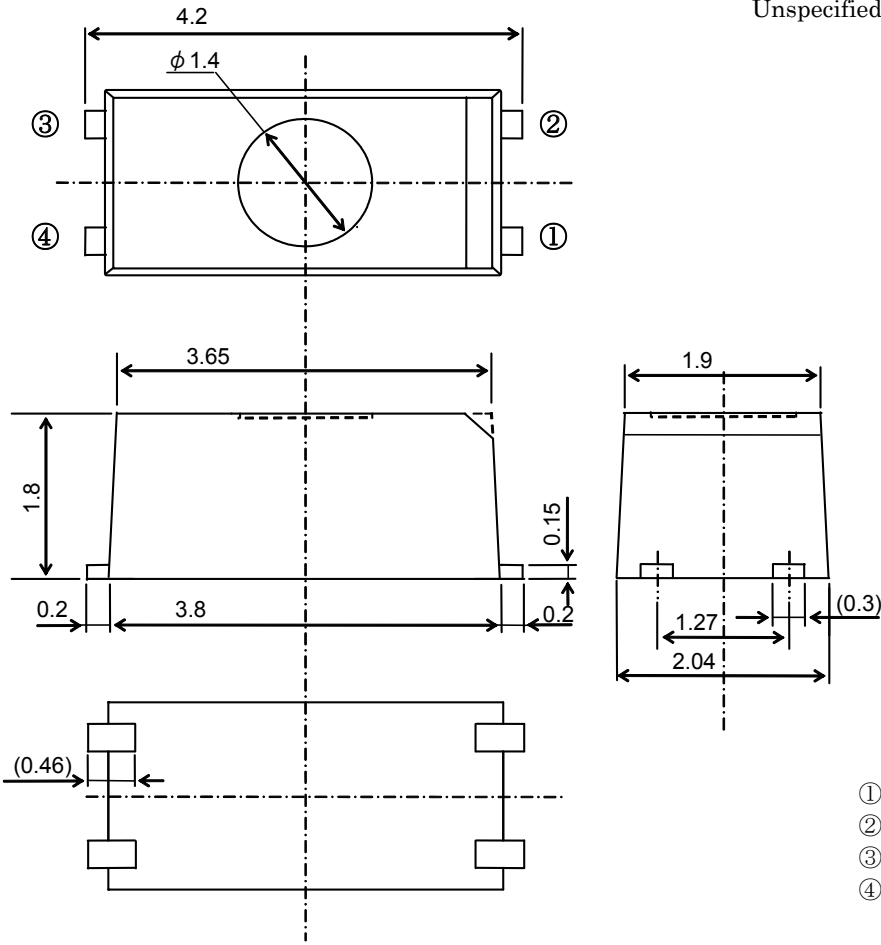
Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Turn-on time	t_{ON}	$R_L = 200 \text{ } \Omega$ (Note 2) $V_{DD} = 20 \text{ V}, I_F = 5 \text{ mA}$	—	100	300	μs
Turn-off time	t_{OFF}		—	100	300	

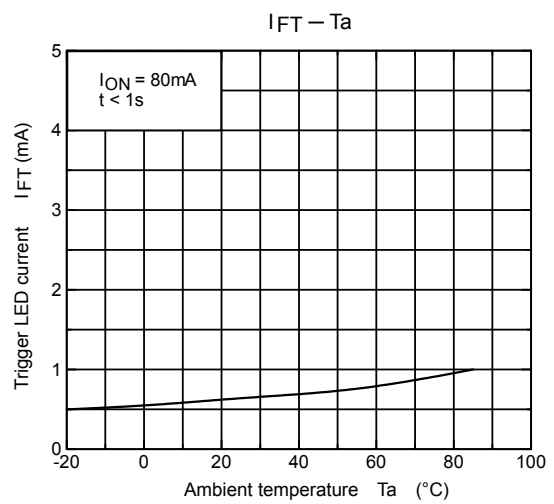
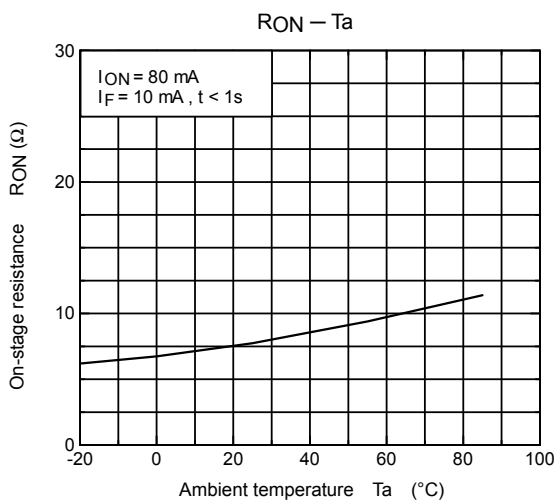
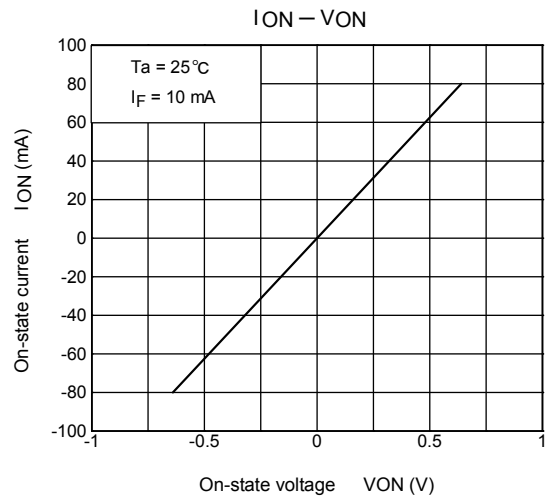
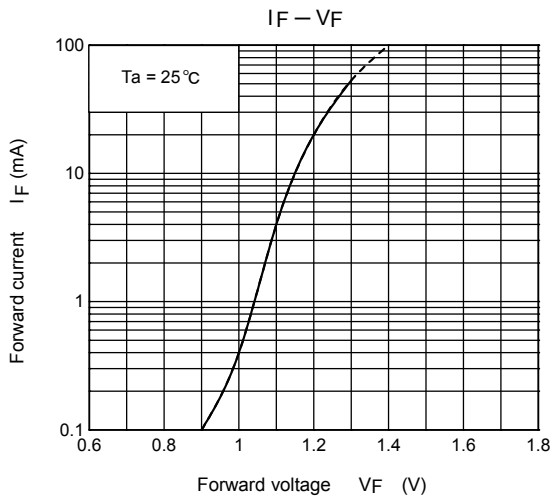
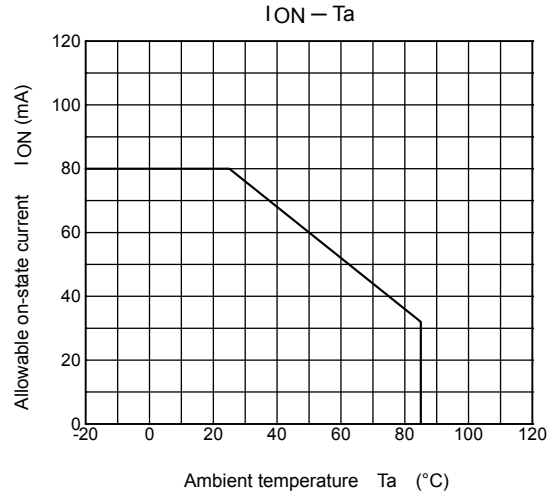
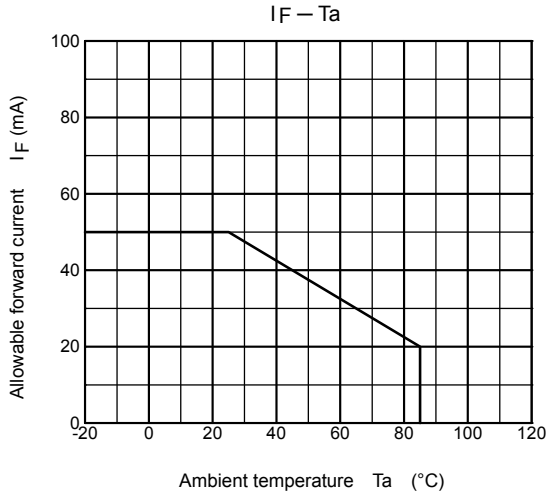
(Note 2): switching time test circuit

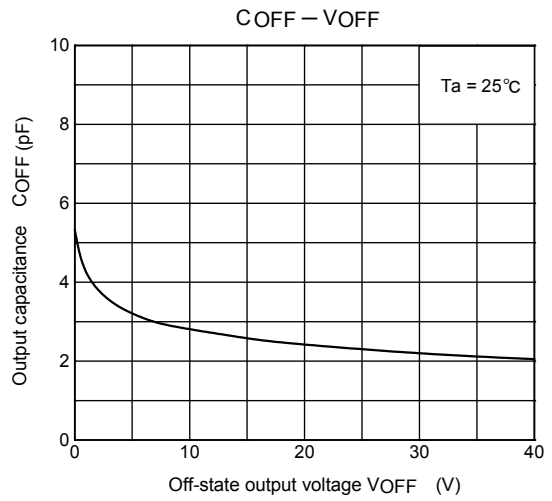
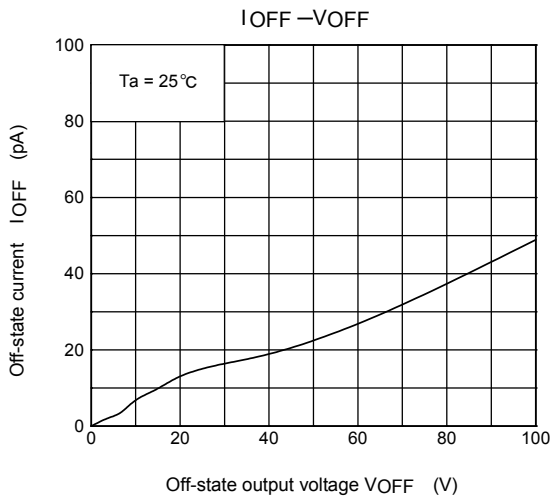
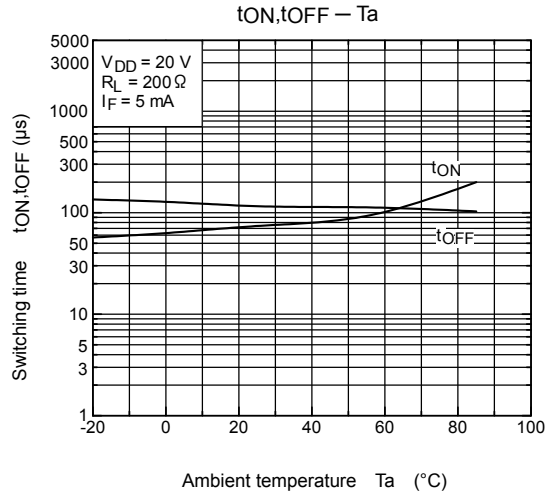
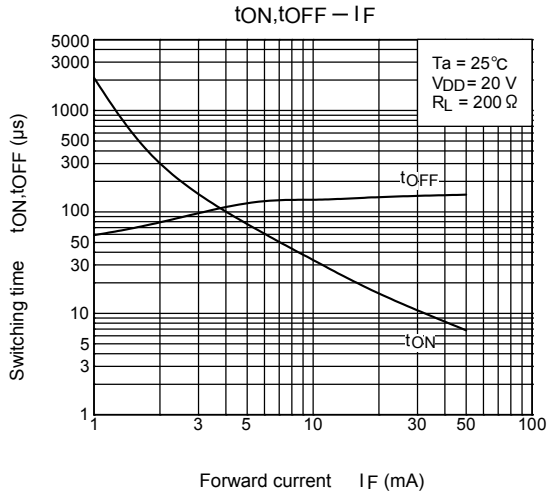


Package Dimensions

Unit: mm
Unspecified tolerance: ±0.1







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